HTA2500 ROBO

Pioneering Fully Automatic Loading and Unloading Design for Reduced Labor and Simplified Workflow

- * Realizes an integrated automated production process of loading + printing + unloading.
- Supports automatic loading and unloading devices (optional configuration).
- Supports manual loading, equipped with a foot pedal for easier and more convenient operation.



Outstanding Hardware and Software Performance

- Independent vacuum-controlled adsorption platform enhances the adsorption force for media of different sizes.
- Full rectangular steel welded frame and guide rail beam ensure overall stability.
- PU conveyor belt for stronger load capacity and enhanced durability.
- O4 Single-channel independent ink supply system to reduce maintenance costs.
- White ink circulation system prevents white ink sedimentation.
- Collision prevention and resume printing function ensures high product yield.
- Integrated control interface centralizes production parameter settings for ease and efficiency.



Technical Parameters:

Model	HTA2500 ROBO	
Printing Information	A Tradebatticel en les banks français partier	
Printhead	Kyocera Industrial-grade Grayscale Printhead	
Number of Printheads	2-18 pcs	
Resolution	605*1800 DPI, 363*3600 DPI	
Productivity	Draft Mode	312 m²/h
	Production Mode	208 m²/h
	Quality Mode	138 m²/h
Printing speed of sheet materials	Quality Mode	60 pcs/h(standard materials)
Printing Modes	Bidirectional high	n speed
Media & Ink		
Max. Print Width	2500 mm	
Max. Media Thickness	50 mm	
Media	Various sheet and roll materials, such as soft film, scraper cloth, vehicle stickers, Honeycomb board, and wooden board	
Ink Type	Eco-friendly UV-curable ink (VOC-free)	
	CMYK, Lc, Lm, W	
Ink Colors	CMYK, Lc, Lm, W	
Ink Colors Software & Functions	CMYK, Lc, Lm, W	
	CMYK, Lc, Lm, W LED curing	
Software & Functions	D - COOKES REPORTED TO THE REPORT OF THE PROPERTY OF THE PROPE	
Software & Functions Curing	LED curing	
Software & Functions Curing Transfer	LED curing High-speed PCIE	EPS, AI
Software & Functions Curing Fransfer RIP nput	LED curing High-speed PCIE Caldera	EPS, Al
Software & Functions Curing Fransfer RIP nput Dimensions & Weight	LED curing High-speed PCIE Caldera	
Software & Functions Curing Fransfer RIP nput Dimensions & Weight	LED curing High-speed PCIE Caldera PDF, JPEG, TIFF, E	mm (L*W*H)
Software & Functions Curing Transfer RIP nput Dimensions & Weight Machine Dimensions	LED curing High-speed PCIE Caldera PDF, JPEG, TIFF, E	mm (L*W*H)
Software & Functions Curing Transfer RIP Input Dimensions & Weight Machine Dimensions Package size	LED curing High-speed PCIE Caldera PDF, JPEG, TIFF, E 5535*2060*1900 r 5840*2280*2250 r	mm (L*W*H)
Software & Functions Curing Transfer RIP Input Dimensions & Weight Machine Dimensions Package size Net Weight	LED curing High-speed PCIE Caldera PDF, JPEG, TIFF, E 5535*2060*1900 r 5840*2280*2250 r	mm (L*W*H)
Software & Functions Curing Transfer RIP Input Dimensions & Weight Machine Dimensions Package size Net Weight Gross Weight	LED curing High-speed PCIE Caldera PDF, JPEG, TIFF, E 5535*2060*1900 r 5840*2280*2250 r	mm (L*W*H)
Software & Functions Curing Transfer RIP Input Dimensions & Weight Machine Dimensions Package size Net Weight Gross Weight Power & Environment	LED curing High-speed PCIE Caldera PDF, JPEG, TIFF, E 5535*2060*1900 r 5840*2280*2250 r 3500 KG 4000 KG	mm (L*W*H) mm (L*W*H)
Software & Functions Curing Transfer RIP Input Dimensions & Weight Machine Dimensions Package size Net Weight Gross Weight Power & Environment Power Consumption	LED curing High-speed PCIE Caldera PDF, JPEG, TIFF, E 5535*2060*1900 r 5840*2280*2250 r 3500 KG 4000 KG 23.1 kW(47A) 400VAC 50Hz 3P/	mm (L*W*H) mm (L*W*H)

Relative Humidity: 30% ~ 70% (non-condensing)